



PATENT
TESSERA 3.0-022

PP1208
Hofa
K. D. Smith
4/1/96

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent application of
Karavakis, et al.

Serial No. 08/246,113

Filed: May 19, 1994

For: METHOD OF ENCAPSULATING
DYE AND CHIP CARRIER

Group Art Unit 1208

Examiner: R. Lovering

Date: March 28, 1996

Assistant Commissioner For Patents
Washington, D.C. 20231

AMENDMENT

Sir:

The present amendment is responsive to the Office Action dated September 28, 1995. A petition for a three-month extension of time to respond is requested and attached. In view of the above amendments and within remarks, reconsideration of the Examiner's rejection and notice of allowance of all pending claims is respectfully requested.

IN THE SPECIFICATION

Page 9, line 32, delete "37".

Page 14, line 14, delete "Figure 10A" and replace with --Figures 10A and 10B--.

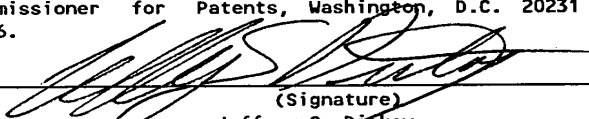
IN THE DRAWINGS

Amendments to the drawings are attached hereto and indicated in red.

IN THE CLAIMS

5. (Amended) The method in Claim 3, wherein the step of curing [the hardening step] includes mixing a plurality of mutually reactive material to form said curable materials during or before said curable material is

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231 on March 28, 1996.


(Signature)
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